

# **Discription**

The ESD9N5B protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. Excellent clamping capability, low leakage, low capacitance, and fast response time provide best in class protection on designs that are exposed to ESD.

It gives designer the flexibility to protect one bi-directional line in applications where arrays are not practical.



DFN1006-2L

#### **Features**

- ★ Low Leakage
- ★ Response Time is Typically < 1 ns
- ★ ESD Rating of Class 3 per Human Body Model
- ★ IEC61000-4-2 Level 4 ESD Protection
- ★ These are Pb-Free Devices
- ★ We declare that the material of product compliance with RoHS requirements and Halogen Free.



Circuit Diagram

### **Orderingin formation**

Product ID	Pack	Qty(PCS)		
ESD9N5B	DFN1006-2L	10000		

# Absolute Ratings(Tamb = 25°C)

Symbol	Parameter		Value	Units
$P_{PP}$	Peak Pulse Power (t <sub>p</sub> = 8/20μs)		66	W
TL	Maximum lead temperature for soldering during 10s		260	°C
$T_{stg}$	Storage Temperature Range		-55 to +150	°C
T <sub>op</sub>	Operating Temperature Range		40 to +125	°C
T <sub>j</sub>	Maximum junction temperature		150	°C
	IEC61000-4-2 (ESD) air dischar contact dischar		±25 ±20	KV



#### **Electrical Characteristics**

	V <sub>RWM</sub> (V)	I <sub>R1</sub> (μΑ) @ V <sub>RWM</sub>	I <sub>R2</sub> (μ <b>A)</b> @ <b>V</b> <sub>R</sub> =3.5V	V <sub>BR</sub> (V) @ ե (Note 2)		Ι <sub>Τ</sub>	V <sub>C</sub> (V) @ I <sub>PP</sub> = 1 A (Note 3)	V <sub>C</sub> (V) @MAX I <sub>PP</sub> (Note 3)	I <sub>PP</sub> (A) (Note 3)	P <sub>PK</sub> (W) (Note 3)	C (pF)
Device	Max	Max	Max	Min	Max	mA	Max	Max	Max	Max	Тур
ESD9N5B	5.0	0.5	0.3	5.6	8.0	1.0	8.5	12	5.5	66	10

Other voltage available upon request.

- 3. Surge current waveform per Figure 3.

# **Typical Characteristics**

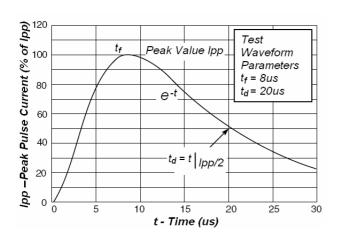


Fig1. Pulse Waveform

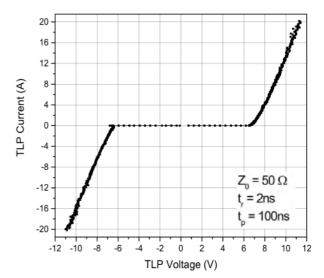
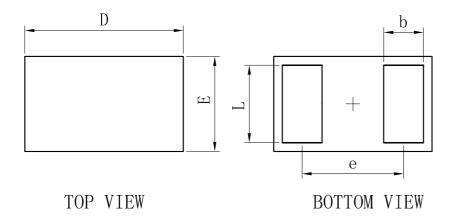
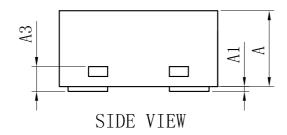


Fig2.TLP Measurement

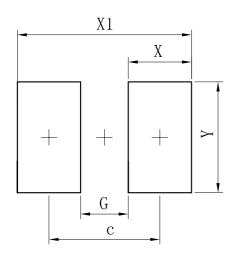
# **Outline And Dimensions**



DFN1006-2L					
Dim	Min	Тур	Max		
D	0. 95	1.00	1.05		
Е	0. 55	0.60	0.65		
е	_	0.64	_		
L	0.44	0.49	0.54		
b	0.20	0. 25	0.30		
A	0. 43	0.48	0. 53		
A1	0	-	0.05		
A3	0. 127REF.				
All Dimensions in mm					



# **Soledering Footprint**



Dimensions	(mm)
С	0.70
G	0.30
X	0.40
X1	1. 10
Y	0.70



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